

HDLX-1414 Series

Four-Character Smart Alphanumeric Displays



Description

These Broadcom[®] 3.7-mm (0.145-in.) four-character 5 × 7 dot matrix displays are driven by an on-board CMOS IC. These displays are pin for pin compatible with the HPDL-1414. The IC stores and decodes 7-bit ASCII data and displays it in an easy to read 5 × 7 font. Multiplexing and LED drive circuitry are also included in the display, and fast setup and hold times allow it to interface easily with common microprocessors.

The address and data inputs can be directly connected to microprocessor address and data buses.

The HDLX-1414 offers a larger character set than the HPDL-1414. Lowercase letters and special symbols are now offered, made possible by the 5 × 7 dot matrix character layout.

The difference between the sunlight-viewable HDLS-1414 and the low-power HDLU-1414 lies in the brightness level. The sunlight-viewable version is internally set to provide high-intensity characters. The low-power version uses the same bright LED technology, but reduces the current through each LED to a much lower level, and maintains an intensity comparable to the HDLO-1414.

Features

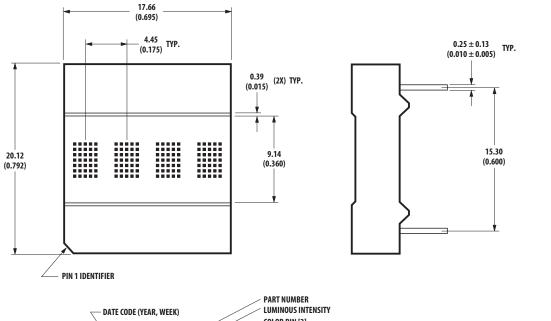
- Dot matrix replacement of HPDL-1414
- Smart alphanumeric display
 Built-in RAM, ASCII decoder, and LED drive circuitry
- 128 ASCII character set
- End stackable
- Categorized for luminous intensity; Yellow and Green categorized for color
- Low-power and sunlight-viewable AllnGaP Deep Red versions
- Wide viewing angle (50° typical)

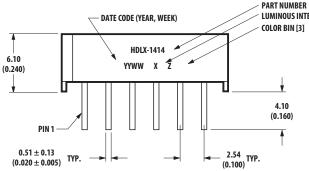
Devices

Deep Red	High Efficiency Red	Orange	Yellow	Green
HDLS-1414 (sunlight view.)	HDLO-1414	HDLA-1414	HDLY-1414	HDLG-1414
HDLU-1414 (low power)				

ESD Warning: Observe standard CMOS handling precautions with the HDLX-1414.

Package Dimensions





PIN NO.	FUNCTION	PIN NO.	FUNCTION
1	D ₅ data input	7	GROUND
2	D ₄ data input	8	D ₀ DATA INPUT
3	WR WRITE	9	D ₁ data input
4	A ₁ DIGIT SELECT	10	D ₂ data input
5	A ₀ DIGIT SELECT	11	D ₃ DATA INPUT
6	V _{DD}	12	D ₆ data input

DIMENSIONS ARE IN MILLIMETERS (INCHES).

Absolute Maximum Ratings

Parameter	Symbol	Min.	Тур.	Max.	Units
Supply Voltage, VDD to Ground ^a		-0.5	_	7.0	V
Input Voltage, Any Pin to Ground		-0.5	_	+0.5	V to V _{DD}
Free Air Operating Temperature Range	T _A	-40	_	+85	°C
Storage Temperature	T _S	-40	_	+100	°C
CMOS IC Junction Temperature		_	_	+150	°C
Relative Humidity (Noncondensing) at +65°C		_	85%	_	
Soldering Temperature (1.59 mm [0.063 in.] Below Body)					
Solder Dipping	Solder Dipping 260°C for 5s				
Wave Soldering		250°C for 3s			
ESD Classification, R = 1.5 kΩ, C = 100 pF		Cla	ss 1 (0 to 199	9V)	

a. Maximum voltage is with no LEDs illuminated.

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Character Set

			DO	0	1	0	1	0	1	0	1	0	1	0	1	0	1	0	1
			D1	0	0	1	1	0	0	1	1	0	0	1	1	0	0	1	1
	ASCII		D2	0	0	0	0	1	1	1	1	0	0	0	0	1	1	1	1
			D3	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
D6	D5	D4	HEX	0	1	2	3	4	5	6	7	8	9	A	В	·	D	E	F
D0	03	77	IILA	-	<u> </u>			-	-	-		•	-	A .	В		_		
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NOTES: 1 = HIGH LEVEL

0 = LOW LEVEL

Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Units
Supply Voltage	V_{DD}	4.5	5.0	5.5	V

Electrical/Optical Characteristics over Operating Temperature Range

 $4.5 < V_{DD} < 5.5V$ (unless otherwise specified).

			-25	−25°C ^a			
Parameter	Symbol	Min.	Тур.	Max.	Max.	Units	Test Conditions
Blank Current	I _{DD} (blnk)	_	1.0	_	4.0	mA	All digits blanked
Input Current	I _I	-40	_	_	10	μΑ	V _{IN} = 0V to V _{DD}
							V _{DD} = 5.0V
Input Voltage High	V _{IH}	2.0	_	_	V_{DD}	V	
Input Voltage Low	V _{IL}	GND	_	_	0.8	V	
IDD 4 Digits	I _{DD} (#)	_	110	130	160	mA	"#" ON in all four locations
20 dots/character ^b , ^c							

a. $V_{DD} = 5.0V$.

b. Average I_{DD} measured at full brightness. Peak I_{DD} = 28/15 × Average I_{DD} (#).

c. I_{DD} (#) max. = 130 mA, 150°C IC junction temperature and V_{DD} = 5.5V.

Optical Characteristics at 25°C¹

 V_{DD} = 5.0V at full brightness.

Deep Red HDLS-1414

Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	l _V	4.0	12.7	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λ_{PEAK}	_	645	nm	
Dominant Wavelength ^a	λ_{D}	_	637	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the device

Deep Red HDLU-1414

Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	I _V	1.2	3.1	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λ _{PEAK}	_	645	nm	
Dominant Wavelength ^a	λ_{D}	_	637	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the device.

High Efficiency Red HDLO-1414

Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	l _V	1.2	3.5	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λ _{PEAK}	_	635	nm	
Dominant Wavelength ^a	λ_{D}	_	626	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the device.

Orange HDLA-1414

Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	I _V	1.2	3.5	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λρΕΑΚ	_	600	nm	
Dominant Wavelength ^a	λ_{D}	_	602	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the device.

^{1.} Refers to the initial case temperature of the device immediately prior to the light measurement.

Yellow HDLY-1414

Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	l _V	1.2	3.7	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λ_{PEAK}	_	583	nm	
Dominant Wavelength ^a	λ_{D}	_	585	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the device.

Green HDLG-1414

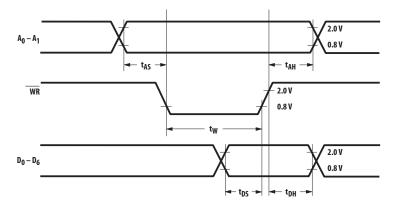
Parameter	Symbol	Min.	Тур.	Units	Test Conditions
Average Luminous Intensity per Digit, Character Average	I _V	1.2	5.6	mcd	"*" illuminated in all four digits. 19 dots ON per digit.
Peak Wavelength	λ_{PEAK}	_	568	nm	
Dominant Wavelength ^a	λ_{D}	_	574	nm	

a. Dominant wavelength, λ_D , is derived from the CIE chromaticity diagram, and represents the single wavelength that defines the color of the

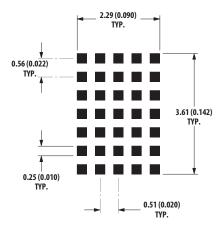
AC Timing Characteristics over Operating Temperature Range at $V_{DD} = 4.5V$

Parameter	Symbol	Min.	Units
Address Setup	t _{AS}	10	ns
Address Hold	t _{AH}	40	ns
Data Setup	t _{DS}	50	ns
Data Hold	t _{DH}	40	ns
Write Time	t _W	75	ns

Timing Diagram



Enlarged Character Font



NOTE:

- 1. Unless otherwise specified, the tolerance on all dimensions is \pm 0.254 mm (0.010 in.).
- 2. Dimensions are in millimeters (in.).

Electrical Description

Pin Function	Description
\Write (\WR, Pin 3)	WR must be logic 0 to store data in the display.
Address Inputs (A ₁ and A ₀ , Pins 4 and 5)	A_0 and A_1 select a specific location in the display memory. Address 00 accesses the far-right character, and address 11 accesses the far-left position.
V _{DD} (Pin 6)	V _{DD} is the positive power supply input.
Ground (GND, Pin 7)	Ground is the display ground.
Data Inputs (D0 to D6, Pins 1, 2, 8 to 12)	D0 to D6 are used to specify the input data for the display.

Display Internal Block Diagram

Figure 1 shows the HDLX-1414 display internal block diagram. The CMOS IC consists of a 4 × 7 Character RAM, a 128-character ASCII decoder and the refresh circuitry necessary to synchronize the decoding and driving of four 5 × 7 dot matrix characters.

Four 7-bit ASCII words are stored in the character RAM. The IC reads the ASCII data and decodes it using the 128-character ASCII decoder. This decoder includes the 64-character set of the HPDL-1414, 32 lowercase ASCII symbols, and 32 foreign language symbols.

Data Entry

Table 1 shows a truth table for the HDLX-1414 display. Address inputs A_0 and A_1 select the digit location in the display. When A_0 and A_1 are both logic low, data is loaded into the right-most character.

Data inputs D0 to D6 load information into the display. Data is latched into the given character address on the rising edge of the \WR signal. Data and Address inputs must be held stable during the write cycle to ensure that correct data is stored in the display.

Mechanical and Electrical Considerations

The HDLX-1414 is a 12-pin DIP package that can be stacked to create a character array of any size. The display is designed to operate reliably in –40°C to +85°C ambient temperatures.

The HDLX-1414 is assembled by die-attaching and wire-bonding 140 LEDs and a CMOS IC to a high temperature printed circuit board. A polycarbonate lens is placed over the PCB, creating a protective air gap over the LED wire bonds. Backfill epoxy environmentally seals the display package. This package construction makes the display highly tolerant to temperature cycling and allows wave soldering.

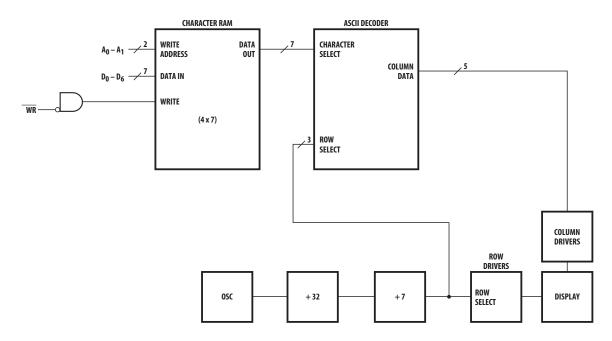
ESD and Latchup Protection

The inputs to the CMOS IC are protected against static discharge and input current latchup. However, for best results, use standard CMOS handling precautions. Prior to use, store the HDLX-1414 in antistatic tubes or conductive material. During assembly, use a grounded conductive work area, and assembly personnel should wear conductive wrist straps. Avoid lab coats made of synthetic material because they are prone to static charge build-up. Input current latchup can be caused when the CMOS inputs are subjected either to a voltage below ground ($V_{\rm in}$ < ground) or higher than $V_{\rm DD}$ ($V_{\rm in}$ > $V_{\rm DD}$) and when a high current is forced into the input. To prevent input current latchup and ESD damage, copnnect unused inputs either to ground or to $V_{\rm DD}$. Do not apply voltages to the inputs until $V_{\rm DD}$ has been turned on, and eliminate high transient input voltages.

Table 1: Display Truth Table

\WR	A1	A0	D6	D5	D4	D3	D2	D1	D0	Function
1	Х	Х	Х	Х	Х	Х	Х	Х	Х	No Change
0	0	0	Digit 0 ASC	Digit 0 ASCII Data (Right-Most Character)				Write to		
0	0	1	Digit 1 ASC	Digit 1 ASCII Data				Character		
0	1	0	Digit 2 ASC	Digit 2 ASCII Data				RAM		
0	1	1	Digit 3 ASCII Data (Left-Most Character)							
0 = Logic 0;	0 = Logic 0; 1 = Logic 1; X = Do Not Care.									

Figure 1: Display Internal Block Diagram



Soldering Instructions

The HDLX-1414 is compatible with hand- and wave-solder processes. Use a no-clean flux.

The polycarbonate lens on these displays is incompatible with some fluxes and cleaning solutions. Do not use with heated Terpene or solutions of propylene glycol monomethyl ether and monoethanolamine.

For further information on soldering and post-solder cleaning, refer to Application Note 1027, *Soldering LED Components*.

Contrast Enhancement

The objective of contrast enhancement is to provide good readability in the end user's ambient lighting conditions. By using both luminance (brightness) and chrominance (color) contrast techniques, the ON dots of the display can be made to stand out against a dark background.

For further information on contrast enhancement, refer to Application Note 1015, *Contrast Enhancement Techniques for LED Displays*.

Intensity Bin Limits for HDLS-1414 Color Bin Limits

	Intensity Range (mcd)		
Bin	Min.	Max.	
E	3.97	6.79	
F	5.55	9.50	
G	7.78	13.30	
Н	10.88	18.62	
I	15.24	26.07	
J	21.33	36.49	

NOTE: Test conditions as specified in Optical

Characteristics at 25°C.

		Color Range (nm)	
Color	Bin	Min.	Max.
Green	1	576.0	580.0
	2	573.0	577.0
	3	570.0	574.0
	4	567.0	571.5
Yellow	3	581.5	585.0
	4	584.0	587.5
	5	586.5	590.0

NOTE: Test conditions as specified in Optical Characteristics at 25°C.

Intensity Bin Limits for HDLX-1414

	Intensity Range (mcd)		
Bin	Min.	Max.	
Α	1.20	1.77	
В	1.45	2.47	
С	2.02	3.46	
D	2.83	4.85	
E	3.97	6.79	
F	5.55	9.50	
G	7.78	13.30	

NOTE: Test conditions as specified in Optical

Characteristics at 25°C.

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